K2 OWNER'S MANUAL ERRATA

Rev. I-3, September 1, 2015

MAKE THESE CHANGES TO YOUR REV. I MANUAL BEFORE YOU BEGIN ASSEMBLY

- 1. Page 20, Right Column, Second Checkbox Step: Delete U1 from the list and delete the associated note.
- 2. Page 20, Right Column, Third Checkbox Step: After the third check-box step insert a note to refer to this errata and perform the following check-box steps to install U1.

The NE602/SA602 integrated circuits (ICs) have been replaced by surface-mount RoHS compliant SA612AD ICs. The SA612AD ICs are furnished pre-installed on tiny printed circuit "carrier" boards that mount in the spaces originally provided for the 8-pin dual in-line (DIP) parts. The new parts are supplied in ESD-safe bags marked SA612AD mounted on SMT1A. There are three identical ICs, each in a separate bag with the wire needed to mount them. The kit also contains a 1350 amplifier I.C. mounted on a similar carrier board. It is supplied in an ESD-safe bag marked MC1350 mounted on SMT1A. Do not confuse the 612 mixers with the 1350 amplifier IC. You can confirm which are the mixers by noting that the numbers on the top of the SA612AD ICs include "612". Similarly, the number "1350" appears on the top of the MC1350 amplifier IC. You may need a good magnifier to read them.

Locate one of the *SA612AD mounted on SMT1A IC* bags. Inside is a length of wire, the IC on small carrier board and an instruction sheet. Install the IC as shown on the instruction sheet. If the carrier board with the IC presses against the side of crystal X1 so the solder pads do not line up with the solder pads on the Control board, carefully sand the side of the carrier board until it fits.

3. Page 25, Left Column: Underline the following sentence in the note at the top of the column. It is very important to take ESD precautions before handling these ICs to avoid electrostatic damage:

Touch a grounded surface before handling each IC.

4.	4. Page 51, Right Column, Fourth and Fifth Checkbox Steps (Installing Q22): Replace the steps with the following;						
	Place the star heat sink onto Q22 (2N5109). You will need to open the gap on the heat sink to allow Q22 to fit. Q22 must be inserted so its shoulder presses against the heat sink. To do this, place the heat sink flat on your work surface in insert a common flat screwdriver in the slot, then twist the screwdriver to pry the slot open so the transistor slips into the center opening until the shoulder on the transistor case is firmly against the heat sink.						
	Install Q22 in the space marked to the right of the Elecraft label. Be sure Q22 is flat against the pc board and solder it in place.						
5.	Page 52, Right Column, First Checkbox Step: U10 and U11 are now supplied mounted on SMT1A carrier boards identical to U1 on page 1 of this errata. Delete U10 and U11 from the list in the step and add the step below.						
	Locate one of the <i>SA612AD mounted on SMT1A</i> bags. Inside is a length of wire, the IC on small carrier board and an instruction sheet. Install the IC as shown on the instruction sheet.						
	_ Install U10.						
	_ Install U11.						
6.	Page 52, Right Column: Delete the note about the 1350 after the first checkbox step and delete the second and third checkbox steps, associated notes and the illustration. Add the step below.						
	Locate the <i>MC1350 mounted on SMT1A</i> bag. Inside is a length of wire, the IC on small carrier board and an instruction sheet. Install the IC as described in the instruction sheet at U12.						
7.	Page 52, Left Column: Delete the first checkbox step.						
8.	Page 60, Left Column, note, second and third checkbox steps : Change SMT1B to <i>BAP64-05 diode mounted on SMT1B Carrier Board</i> .						
9.	Page 68, Right Column, in the section starting: "Install the trimmers listed below"						
	Change the value listed from C44 and C46 from "30 pF" to "20 pF"						
	C44 and C46 will be in a small envelope in the K2 RFa bag. Note: There may						

- **10. Appendix A, K2 RF Board Parts List, Page 3:** Replace the page with page 3 of this errata showing the revised entries for C32 and C34, C44 and C46 and D36.
- 11. Appendix A, K2 RF Board Parts List, Page 7: Replace the page with page 4 of this errata showing the revised entries for U10 and U11.
- **12. Appendix A, K2 Control Board Parts List, Page 3**: Replace the page with page 4 of this errata showing the revised entry for U1.

Appendix A	K2 RF Board Parts List (p/n E850001A and E850001B)				
PICTURE	Designators	Value	Description	Part Number	QTY
	C32, C34	var,10-50pF	ceramic trimmer (see below to tell from 8-50 pF. There may be 2 extra in some kits.)	E540002	2
	C44, C46,	var,5-30pF	ceramic trimmer (see below to tell from 8-50 pF)	E540001	4
	C21, C23	var,8-50pF	ceramic trimmer (red mark or bagged separately)	E540000	2
	D9	1N5711	orange glass body	E560004	1
	D1, D2, D3, D4, D5, D6, D7	1N4007	large black body, silver band	E560001	7
	D8, D11, D13, D18, D40, D41	1N4148	clear or blue glass body	E560002	6
0 1-1-5 0 -3	D36	BAP64-05 diode mounted on SMT1B Carrier Board	pin diode supplied on pc daughterboard	E120014	1
100	D10	95SQ015	ultra-low-drop shottky diode, 9A, very large black body	E560009	1
	D12	SB530 (alternate: 1N5821)	shottky diode, 5A, very large black body	E560003	1
	D16, D23, D24, D25, D26, D39 (also D19-D20see description)	MV209	TO-92, 2 leads D19-D20 supplied with K60XV option	E560006	6
	D17, D21, D22, D29, D30, D31, D32, D33, D34, D37, D38	1SV149	TO-92, 2 leads	E560005	11
	F1	RGE300	Resettable fuse; (YELLOW) "G300" Looks like a larger monolithic cap.	E980018	1
	J8	10x2,female socket	10 x 2 female socket	E620038	1
	J7	18x2,female socket	18 x 2 female socket	E620039	1

Appendix A	K2 RF Board Parts List (p/n E850001A and E850001B)				
PICTURE	Designators	Value	Description	Part Number	QTY
	U3, U9	LT1252	8 pin DIP, VFO Buffer; TX Buffer	E600020	2
	U5	LTC1451	8 pin DIP, 12-Bit DAC for Reference Freq. Of PLL	E600030	1
NAT .	U6	LMC662	8 pin DIP, (rail-to-rail out); PLL Loop filter	E600026	1
O1 80	U10, U11	SA612AD mounted on SMT1A	Mixer SMC on SMT1A carrier board with a length of #24 wire and installation instruction sheet	E850727	2
o; ; o □4 5□	U12	MC1350 mounted on SMT1A	IF Amp/AGC SMC on SMT1A carrier board with a length of #24 wire and installation instruction sheet	E850726	1
	U8	78L05	5-volt reg. (100mA)	E600029	1
	U4	MC145170P2 (or P1)	16 pin DIP, PLL	E600016	1
	W1, W2, W3, W5, W6	1" bare wire	Use component leads		0
(242)	X1 (X2 not used)	12096 kHz	PLL reference oscillator crystal; HC-49	E850007	1
91.AN	X3, X4	4915.2 kHz	BFO crystals; matched set; HC-49 Typical labeling: ECS D 4.91 -S	E850008	2
	X5, X6, X7, X8, X9, X10, X11	4913.6 kHz	Filter crystals; matched set, HC-49 Typical labeling: ECS V 4.9136-S	E850006	7
	Z5	4.000MHz Resonator	Ceramic resonator w/caps; 0.2% tolerance	E660001	1

Appendix A	K2 Control Board Parts Lis	st (p/n E850002)			
PICTURE	Designators	Value	Description	Part Number	QTY
E.E	R1	50K Trimmer	AGC Threshold	E520011	1
	RP5	470,5R ISO "10A3- 471G"	SIP resistor pack, 10 pins; ALT: "770103471"	E510015	1
	RP1	3.9K,5R ISO "770103392"	SIP resistor pack, 10 pins; ALT: "10A3392G"	E510014	1
\$2000000000000000000000000000000000000	RP6	5.1K,5R ISO "770103512"	"10A3512G"	E510013	1
	RP7	333G"	"77083333"	E510016	1
	RP3	473G"	770103473"	E510007	1
	RP2, RP4	82K,4R ISO "77083823"	SIP resistor pack, 8 pins; ALT: "08A3823G"	E510011	2
	U2	LM833N	Dual Op Amp, 8 pins	E600012	1
	U3	LMC6482AIN	Dual Op Amp, 8 pins	E600011	1
Gr.	U9	LM380N-8	Audio Amplifier, 8 pins	E600019	1
	U7	National	E600009	1	
01 80 01 0 01 0 01 0 01 50	U1		with a length of #24 wire and	E850727	1
A STATE OF THE PARTY OF THE PAR	U10	LMC660	Quad Op Amp, 14 pins	E600025	1
diame.	U8	MAX534	Quad, 8-bit DAC, 16 pins	E600031	1
101	U4	LM2930T-8	8 Volt regulator, TO-220 Pkg.	E600018	1
C COCO	U5			E600024	1
tananananan .	U6	PIC18C452	MCU, Programmed, 40 pins	E610002	1